

Single-Phase Voltage Regulator with SVID

Product Preview

NCP3293

High Efficiency, Integrated Power MOSFETs

The NCP3293, a single-phase synchronous buck regulator with SVID, integrates power MOSFETs to provide a high-efficiency and compact-footprint power management solution. The NCP3293 is able to deliver up to 20 A TDC output current on a wide output voltage range. Operating in high switching frequency up to 1 MHz allows employing small size inductors and capacitors while maintaining high efficiency due to integrated solution with high performance power MOSFETs. It provides differential voltage sense and comprehensive protections.

Features

- $V_{in} = 4.5\text{ V} \sim 18\text{ V}$
- $V_{out} = 0.5\text{ V} \sim 2.0\text{ V}$ to Support Intel VR13 and VR13.HC SVID
- Integrated Power MOSFETs
- Up to 20 A Continuous Output Current and 30 A Pulse Current
- Integrated 5 V LDO or External 5 V Supply
- Enable with Programmable V_{in} UVLO
- 600 k / 800 k / 1000 kHz Switching Frequency
- Selectable Forced CCM and Auto DCM/CCM
- 16 Selectable Boot Voltages
- 16 Selectable SVID Addresses
- Output Discharge in Shutdown
- Programmable Current Limit
- Latch-Off Over-Voltage and Under-Voltage Protection
- Recoverable Thermal Shutdown Protection
- PQFN37, 5 x 6 mm, 0.5 mm Pitch Package
- This is a Pb-Free Device

Typical Applications

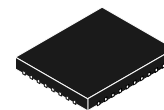
- Point of Load
- Computing Applications
- Telecom and Networking
- Server and Storage System

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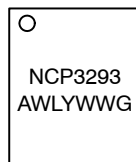
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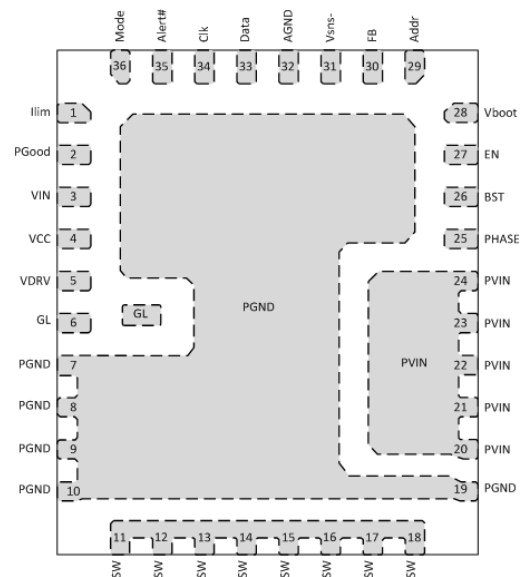
PQFN37 5x6, 0.5P
CASE 483BZ

A = Assembly Site
WL = Wafer Lot Number
Y = Year of Production
WW = Work Week Number
G = Pb-Free Designator

MARKING DIAGRAM



PINOUT



(Top View)

ORDERING INFORMATION

| Device | Package | Shipping† |
|--------------|------------------|--------------------|
| NCP3293MNTXG | PQFN37 (Pb-Free) | 2500 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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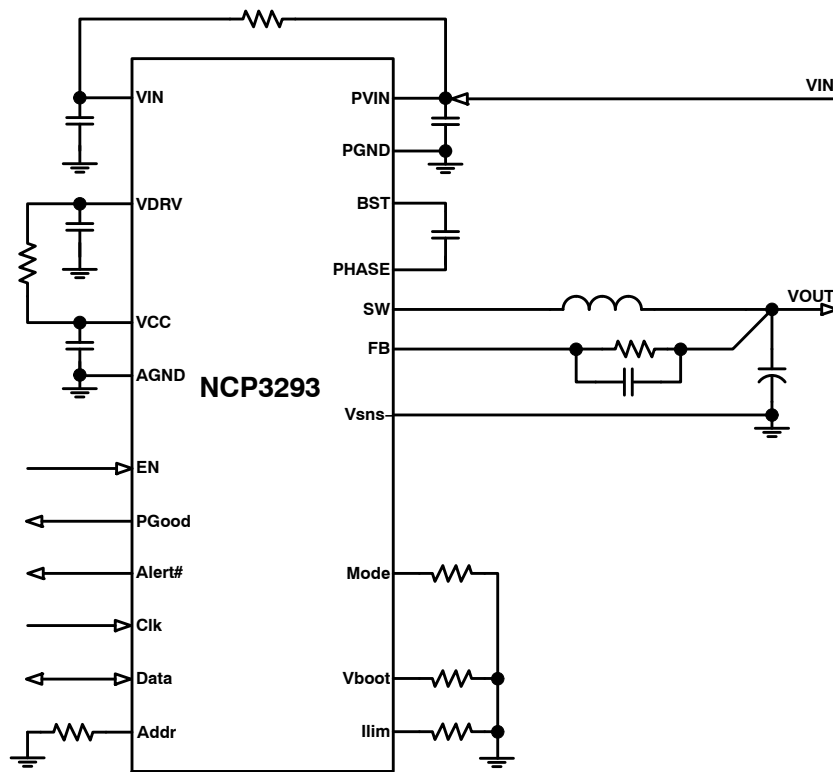


Figure 1. Typical Application Circuit with Single Input Power Supply (LDO Enabled)

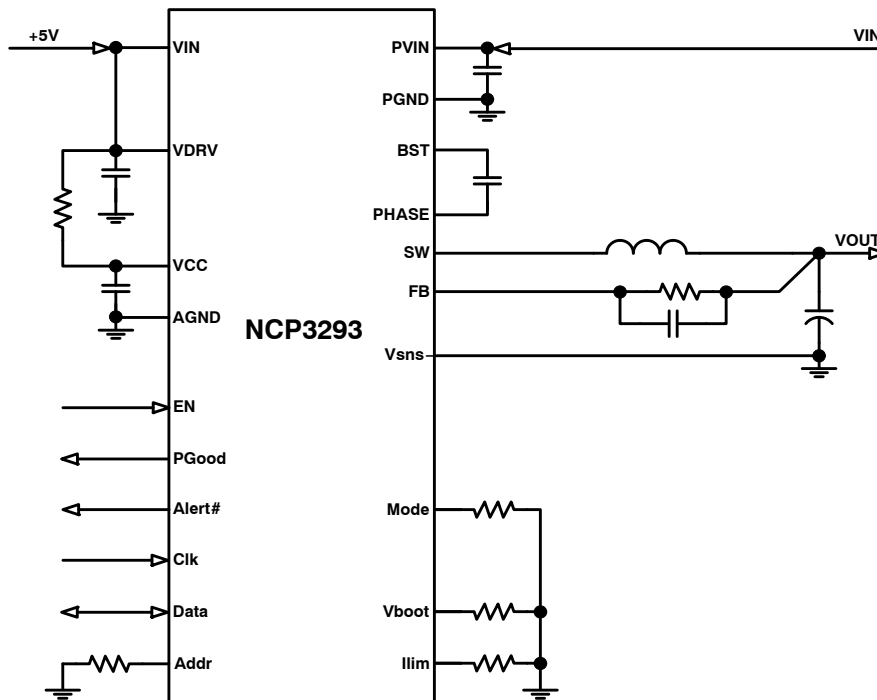


Figure 2. Typical Application Circuit with External 5 V Supply for VCC (LDO Disabled)

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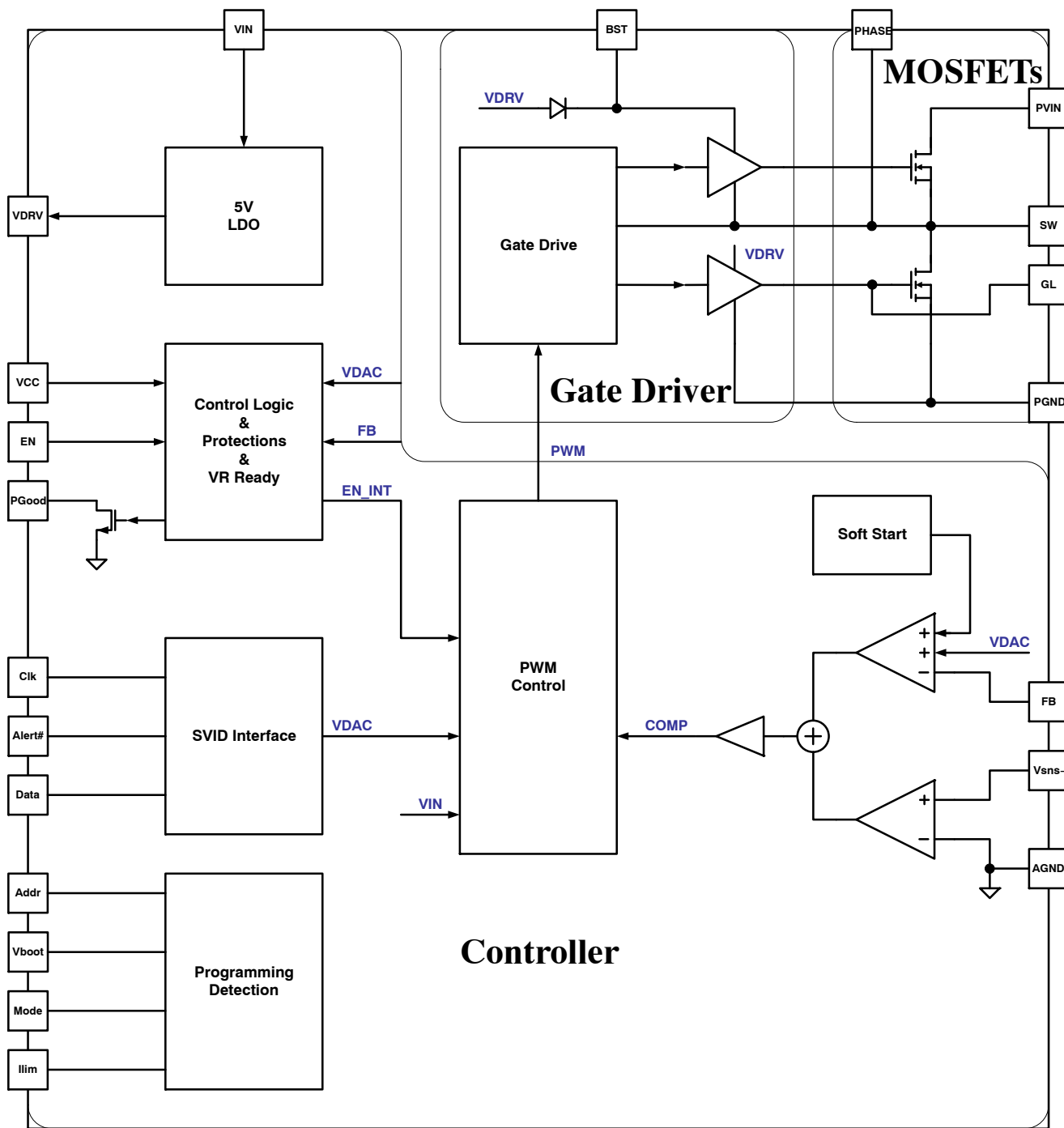


Figure 3. Functional Block Diagram

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Table 1. PIN DESCRIPTION

| Pin | Name | Type | Description |
|---------|--------|---------------------|--|
| 1 | Ilim | Analog Output | Current Limit. A resistor between this pin and AGND to program current limit. |
| 2 | PGood | Logic Output | Power GOOD. Open–drain output. Provides a logic high valid power good output signal, indicating the regulator’s output is in regulation window. |
| 3 | VIN | Power Input | Power Supply Input of LDO. Power supply input pin of internal 5 V LDO. A 1.0 μ F or more ceramic capacitors must bypass this input to power ground. The capacitors should be placed as close as possible to this pin. A direct short from this pin to VDRV (pin 5) disables the internal LDO for applications with an external 5 V supply as power of VDRV and VCC. |
| 4 | VCC | Analog Power | Supply Voltage Input of Controller. A 2.2 μ F or larger ceramic capacitor bypasses this input to GND. This capacitor should be placed as close as possible to this pin. |
| 5 | VDRV | Analog Power | Output of LDO and Supply Voltage Input of Gate Drivers. Output of integrated 5.0 V LDO and power supply input pin of gate drivers. A 4.7 μ F / 25 V or larger ceramic capacitor bypasses this input to PGND. This capacitor should be placed as close as possible to this pin. |
| 6 | GL | Analog Output | Gate of Low–Side MOSFET. Directly connected with the gate of the low–side power MOSFET. |
| 7~10,19 | PGND | Power Ground | Power Ground. These pins are the power supply ground pins of the device, which are connected to source of internal low–side power MOSFET. Must be connected to the system ground. |
| 11~18 | SW | Power Bidirectional | Switch Node. Pins to be connected to an external inductor. These pins are interconnection between internal high–side MOSFET and low–side MOSFET. |
| 20~24 | PVIN | Power Input | Power Supply Input. These pins are the power supply input pins of the device, which are connected to drain of internal high–side power MOSFET. A 22 μ F or more ceramic capacitors must bypass this input to PGND. The capacitors should be placed as close as possible to these pins. |
| 25 | PHASE | Power Return | Phase Node. Provides a return path for integrated high–side gate driver. It is internally connected to source of high–side MOSFET. |
| 26 | BST | Power Bidirectional | Bootstrap. Provides bootstrap voltage for high–side gate driver. A 0.22 μ F / 25 V ceramic capacitor is required from this pin to PHASE (pin 25). |
| 27 | EN | Logic Input | Enable. Logic high enables controller while logic low disables controller. Input supply UVLO can be programmed at this pin. |
| 28 | Vboot | Analog Input | Boot–Up Voltage. A resistor from this pin to ground programs boot–up voltage. |
| 29 | Addr | Analog Input | SVID Address. A resistor from this pin to ground programs SVID address. |
| 30 | FB | Analog Input | Feedback. Inverting input to error amplifier. |
| 31 | Vsns– | Analog Input | Voltage Sense Negative Input. Connect this pin to remote voltage negative sense point. |
| 32 | AGND | Analog Ground | Analog Ground. Ground of controller. Must be connected to the system ground. |
| 33 | Data | Logic Bidirectional | Serial Data IO Port. Data port of SVID interface. |
| 34 | Clk | Logic Input | Serial Clock. Clock input of SVID interface. |
| 35 | Alert# | Logic Output | ALERT#. Open–drain output. Provides a logic low valid alert signal of SVID interface. |
| 36 | Mode | Analog Input | Mode. A resistor between this pin and AGND to program operation mode, nominal switching frequency, and options. |

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Table 2. MAXIMUM RATINGS

| Rating | Symbol | Value | | Unit |
|---|---------------------|----------------------|-------------------|------|
| | | Min | Max | |
| Power Supply Voltage to PGND | V_{PVIN}, V_{VIN} | | 23 | V |
| PHASE/SW to PGND | V_{PHASE}, V_{SW} | -0.6 -5 (<50 ns) | 23 25 (<10 ns) | V |
| Driver Supply Voltage to PGND | VDRV | -0.3 | 5.5 | V |
| Analog Supply Voltage to AGND | VCC | -0.3 | 6.5 | V |
| BST to PGND | BST_PGND | -0.3 | 30 33 (<50 ns) | V |
| BST to PHASE/SW | BST_PHASE/SW | -0.3 | 6.5 | V |
| GL to PGND | GL | -0.3 -2 (<200 ns) | VDRV+0.3 | V |
| Vsns- to AGND | Vsns- | -0.2 | 0.2 | V |
| PGND to AGND | PGND | -0.3 | 0.3 | V |
| Other Pins | | -0.3 | VCC+0.3 | V |
| Human Body Model (HBM) ESD Rating are (Note 1) | ESD HBM | | 2000 | V |
| Charge Device Model (CDM) ESD Rating are (Note 1) | ESD CDM | | 2000 | V |
| Latch up Current: (Note 2) | I_{LU} | -100 | 100 | mA |
| Operating Junction Temperature Range | T_J | -40 | 125 | °C |
| Operating Ambient Temperature Range | T_A | -40 | 100 | °C |
| Storage Temperature Range | T_{STG} | -55 | 150 | °C |
| Thermal Resistance Junction to Top Case(Note 3) | $R_{\psi JC}$ | | 1.0 | °C/W |
| Thermal Resistance Junction to Board (Note 3) | $R_{\psi JB}$ | | 1.2 | °C/W |
| Thermal Resistance Junction to Ambient (Note 3) | $R_{\theta JA}$ | | 27.0 | °C/W |
| Maximum Power Dissipation (Note 4) | P_D | | 3.70 | W |
| Moisture Sensitivity Level (Note 5) | MSL | | 1 | - |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. This device is ESD sensitive. Handling precautions are needed to avoid damage or performance degradation.
2. Latch up Current per JEDEC standard: JEDEC78 class II.
3. The thermal resistance values are dependent of the internal losses split between devices and the PCB heat dissipation. This data is based on a typical operation condition with a 4-layer FR-4 PCB board, which has two, 1-ounce copper internal power and ground planes and 2-ounce copper traces on top and bottom layers with approximately 80% copper coverage. No airflow and no heat sink applied (reference EIA/JEDEC 51.7). It also does not account for other heat sources that may be present on the PCB next to the device in question (such as inductors, resistors etc.)
4. The maximum power dissipation (PD) is dependent on input voltage, output voltage, output current, external components selected, and PCB layout. The reference data is obtained based on $T_{JMAX} = 125^{\circ}C$ and $T_A = 25^{\circ}C$.
5. Moisture Sensitivity Level (MSL): IPC/JEDEC standard: J-STD-020A.

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Table 3. ELECTRICAL CHARACTERISTICS ($V_{IN} = 12\text{ V}$, typical values are referenced to $T_A = T_J = 25^\circ\text{C}$, Min and Max values are referenced to $T_A = T_J = -40^\circ\text{C}$ to 125°C , unless other noted.)

| Characteristics | Test Conditions | Symbol | Min | Typ | Max | Units | |
|---|---|--|------|---|-----|-----------------------------|---|
| SUPPLY VOLTAGE MONITOR | | | | | | | |
| VCC Under-Voltage (UVLO) Threshold | VCC falling | V_{DDUV-} | 4.0 | | | V | |
| VCC OK Threshold | VCC rising | V_{DDOK} | | | 4.4 | V | |
| VCC UVLO Hysteresis | | V_{DDHYS} | | 200 | | mV | |
| SUPPLY CURRENT | | | | | | | |
| PVIN Shutdown Current | EN low | I_{SDPVIN} | - | 0.062 | 6 | μA | |
| VIN Quiescent Supply Current (VCC Current Included) | EN high, no switching, LDO enabled, $V_{IN}=18\text{V}$, $V_{CC}=V_{DRV}$ | I_{QVIN} | - | 11 | 18 | mA | |
| | EN high, no switching, LDO disabled, $V_{IN}=V_{DRV}=V_{CC}=4.5\text{V}$ | | - | 11 | 18 | | |
| VIN Shutdown Current (VCC Current Included) | EN low, LDO enabled, $V_{IN}=18\text{V}$, $V_{CC}=V_{DRV}$ | I_{SDVIN} | - | 27 | 45 | μA | |
| | EN low, LDO disabled, $V_{IN}=V_{DRV}=V_{CC}=4.5\text{V}$ | | - | 60 | 100 | | |
| 5 V LINEAR REGULATOR | | | | | | | |
| Output Voltage | $6\text{V} < V_{IN} < 18\text{V}$, $I_{DRV} = 0$ to 30mA (External) EN high, no Switching | V_{DRV} | 4.8 | 5.0 | 5.3 | V | |
| Dropout Voltage | $V_{IN} = 5\text{V}$, $I_{DRV} = 50\text{mA}$ (External), EN high, no Switching | V_{DO} | | | 250 | mV | |
| PWM MODULATION | | | | | | | |
| Minimum On Time | (Note 6) | T_{on_min} | | 50 | | ns | |
| Minimum Off Time | (Note 6) | T_{off_min} | | 200 | | ns | |
| REGULATION ACCURACY | | | | | | | |
| System Voltage Accuracy | 5 mV VID Step Mode | $1.0\text{V} \leq \text{DAC} \leq 1.52\text{V}$ $0.8\text{V} \leq \text{DAC} \leq 0.995\text{V}$ $0.25\text{V} \leq \text{DAC} \leq 0.795\text{V}$ | | -0.5%• DAC -5m -8m | | 0.5%• DAC +5m +8m | V |
| | 10 mV VID Step Mode | $1.5\text{V} \leq \text{DAC} \leq 2.0\text{V}$ $1.0\text{V} \leq \text{DAC} \leq 1.49\text{V}$ $0.5\text{V} \leq \text{DAC} \leq 0.99\text{V}$ | | -0.5%• DAC -8m -10m | | 0.5%• DAC +8m +10m | |
| DVID | | | | | | | |
| Fast Slew Rate | Programmed at Mode Pin | FSR | | 10 | | mV/ μs | |
| | | | | 20 | | | |
| Slow Slew Rate | | SSR | | FSR/2 FSR/4 (default) FSR/8 FSR/16 | | mV/ μs | |
| VOLTAGE ERROR AMPLIFIER | | | | | | | |
| FB Bias Current | $V_{FB} = 1.0\text{ V}$ | I_{FB} | -50 | | 50 | nA | |
| CURRENT-SENSE AMPLIFIER | | | | | | | |
| Closed-Loop DC Gain | | $GAIN_{CA}$ | | -12.2 | | V/V | |
| -3 dB Gain Bandwidth | (Note 6) | BW_{CA} | | 10 | | MHz | |
| Input Offset Voltage | $V_{osCS} = V_{SW} - V_{PGND}$ (Note 6) | V_{osCS} | -500 | - | 500 | μV | |

6. Guaranteed by design, not tested in production.

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| Characteristics | Test Conditions | Symbol | Min | Typ | Max | Units |
|---|--|---------------------------------|-------------------|-------|------|-------------------|
| ENABLE | | | | | | |
| EN ON Threshold | | V_{EN_TH} | 0.69 | 0.79 | 0.88 | V |
| Hysteresis Resistance | | R_{HYS} | | 40 | | k Ω |
| Hysteresis Current | | I_{EN_HYS} | | 5 | | μA |
| EN Input Leakage Current | EN = 0V | I_{EN_LK} | | | 1.0 | μA |
| SWITCHING FREQUENCY | | | | | | |
| Switching Frequency in CCM | Programmed at Mode Pin (Note 6) | F_{SW} | | 1000 | | kHz |
| | | | | 800 | | |
| | | | | 600 | | |
| Source Current from Mode Pin | | I_{FSET} | 48.5 | 50 | 51.5 | μA |
| SOFT START | | | | | | |
| System Reset Time | Measured from EN to start of soft start | T_{RST} | 0.8 | 0.93 | 1.1 | ms |
| Soft Start Slew Rate | | SSSR | | FSR/4 | | mV/ μs |
| PGOOD | | | | | | |
| PGOOD Startup Delay | Measured from end of Soft Start to PGOOD assertion | T_{d_PGOOD} | | | 6 | μs |
| PGOOD Shutdown Delay | Measured from EN to PGOOD de-assertion | | | 5 | | μs |
| PGOOD Low Voltage | $I_{PGOOD} = -4\text{ mA}$ | V_{IPGOOD} | | | 0.3 | V |
| PGOOD Leakage Current | PGOOD = 5 V | $I_{lkgPGOOD}$ | | | 1.0 | μA |
| PROTECTIONS | | | | | | |
| Valley Current Limit Threshold | $T_A = T_J = 25^\circ\text{C}$ | $R_{LIM} = 31.6\text{ k}\Omega$ | I_{LMT_Valley} | | 30 | A |
| | | $R_{LIM} = 26.1\text{ k}\Omega$ | | | 25 | |
| | | $R_{LIM} = 21.0\text{ k}\Omega$ | | | 20 | |
| | | $R_{LIM} = 15.4\text{ k}\Omega$ | | | 15 | |
| | | $R_{LIM} = 10.2\text{ k}\Omega$ | | | 10 | |
| | | $R_{LIM} = 5.23\text{ k}\Omega$ | | | 5 | |
| Fast Under Voltage Protection (FUVP) Threshold | FB to AGND | | 0.15 | 0.2 | 0.25 | V |
| Fast Under Voltage Protection (FUVP) Delay | (Note 6) | | | 1.0 | | μs |
| Slow Under Voltage Protection (SUVP) Threshold | COMP to AGND (Note 6) | | | 3.0 | | V |
| Slow Under Voltage Protection (SUVP) Delay | (Note 6) | | | 50 | | μs |
| Absolute Over Voltage Threshold During Soft-Start | FB to AGND | | 1.92 | 2.0 | 2.08 | V |
| Absolute Over Voltage Threshold Hysteresis | (Note 6) | | | -25 | | mV |
| Over Voltage Threshold Above DAC | FB rising | V_{OVTH} | 165 | 200 | 225 | mV |
| Over Voltage Protection Hysteresis | FB falling (Note 6) | V_{OVHYS} | | -25 | | mV |
| Over Voltage Debounce Time | FB rising to GL high (Note 6) | | | 1.0 | | μs |
| Thermal Shutdown (TSD) Threshold | (Note 6) | T_{sd} | 140 | 150 | | $^\circ\text{C}$ |

6. Guaranteed by design, not tested in production.

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Table 3. ELECTRICAL CHARACTERISTICS ($V_{IN} = 12\text{ V}$, typical values are referenced to $T_A = T_J = 25^\circ\text{C}$, Min and Max values are referenced to $T_A = T_J = -40^\circ\text{C}$ to 125°C , unless other noted.)

| Characteristics | Test Conditions | Symbol | Min | Typ | Max | Units |
|--------------------------------------|--|-----------|--------|---------|--------|------------------|
| PROTECTIONS | | | | | | |
| Recovery Temperature Threshold | (Note 6) | T_{rec} | | 125 | | $^\circ\text{C}$ |
| Thermal Shutdown (TSD) Debounce Time | (Note 6) | | | 125 | | ns |
| TEMPERATURE TELEMETRY | | | | | | |
| Temperature Telemetry Tolerance | $T_A = T_J = 90\sim 120^\circ\text{C}$ (Note 6) | | -4.0 | | +4.0 | $^\circ\text{C}$ |
| VBOOT | | | | | | |
| Sensing Current | | | 9.7 | 10 | 10.3 | μA |
| ADDRESS | | | | | | |
| Sensing Current | | | 9.7 | 10 | 10.3 | μA |
| IMAX | | | | | | |
| Sensing Current | | | 12.125 | 12.5 | 12.875 | μA |
| CLK, DATA | | | | | | |
| Input High Voltage | | V_{IH} | 0.65 | | | V |
| Input Low Voltage | | V_{IL} | | | 0.45 | V |
| Input Threshold Hysteresis | | V_{HYS} | | 85 | | mV |
| Buffer On Resistance (Data) | | R_{ON} | 4 | | 13 | Ω |
| Input Leakage Current | Pin voltage between 0 and 1.05 V | | -1 | | 1 | μA |
| Input Capacitance | (Note 6) | | | | 4.0 | pF |
| VR Clock to Data Delay | Time between Clk rising edge and valid Data level (Note 6) | T_{co} | 4 | | 12 | ns |
| Setup Time | Time before Clk falling (sampling) edge that Data level must be valid (Note 6) | T_{su} | 7 | | | ns |
| Hold Time | Time after Clk falling edge that the Data level remains valid (Note 6) | T_{hld} | 14 | | | ns |
| ALERT# | | | | | | |
| Output On Resistance | | R_{ON} | 4 | | 13 | Ω |
| Output Leakage Current | High Impedance State, ALERT # = 3.3 V | | -1.0 | - | 1.0 | μA |
| ADC | | | | | | |
| Voltage Range | (Note 6) | | 0 | | 2.0 | V |
| Total Unadjusted Error (TUE) | (Note 6) | | -1 | | 1 | % |
| Differential Nonlinearity (DNL) | 8-bit (Note 6) | | | | 1 | LSB |
| Power Supply Sensitivity | (Note 6) | | | ± 1 | | % |
| Conversion Time | (Note 6) | | | 30 | | μs |
| Round Robin | (Note 6) | | | 90 | | μs |

6. Guaranteed by design, not tested in production.

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Table 4. VR13 VID CODES

| VID7 | VID6 | VID5 | VID4 | VID3 | VID2 | VID1 | VID0 | Voltage(V) | | HEX | VID7 | VID6 | VID5 | VID4 | VID3 | VID2 | VID1 | VID0 | Voltage(V) | | HEX |
|------|------|------|------|------|------|------|------|------------|------------|-----|------|------|------|------|------|------|------|------|------------|------------|-----|
| | | | | | | | | 5 mV Mode | 10 mV Mode | | | | | | | | | | 5 mV Mode | 10 mV Mode | |
| | | | | | | | | 0 | 0 | | | | | | | | | | 0 | 0 | |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0.250 | 0.500 | 01 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | 1 | 0.490 | 0.980 | 31 |
| 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0.255 | 0.510 | 02 | 0 | 0 | 1 | 1 | 0 | 0 | 1 | 0 | 0.495 | 0.990 | 32 |
| 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0.260 | 0.520 | 03 | 0 | 0 | 1 | 1 | 0 | 0 | 1 | 1 | 0.500 | 1.000 | 33 |
| 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0.265 | 0.530 | 04 | 0 | 0 | 1 | 1 | 0 | 1 | 0 | 0 | 0.505 | 1.010 | 34 |
| 0 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | 0.270 | 0.540 | 05 | 0 | 0 | 1 | 1 | 0 | 1 | 0 | 1 | 0.510 | 1.020 | 35 |
| 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | 0.275 | 0.550 | 06 | 0 | 0 | 1 | 1 | 0 | 1 | 1 | 0 | 0.515 | 1.030 | 36 |
| 0 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 0.280 | 0.560 | 07 | 0 | 0 | 1 | 1 | 0 | 1 | 1 | 1 | 0.520 | 1.040 | 37 |
| 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0.285 | 0.570 | 08 | 0 | 0 | 1 | 1 | 1 | 0 | 0 | 0 | 0.525 | 1.050 | 38 |
| 0 | 0 | 0 | 0 | 1 | 0 | 0 | 1 | 0.290 | 0.580 | 09 | 0 | 0 | 1 | 1 | 1 | 0 | 0 | 1 | 0.530 | 1.060 | 39 |
| 0 | 0 | 0 | 0 | 1 | 0 | 1 | 0 | 0.295 | 0.590 | 0A | 0 | 0 | 1 | 1 | 1 | 0 | 1 | 0 | 0.535 | 1.070 | 3A |
| 0 | 0 | 0 | 0 | 1 | 0 | 1 | 1 | 0.300 | 0.600 | 0B | 0 | 0 | 1 | 1 | 1 | 0 | 1 | 1 | 0.540 | 1.080 | 3B |
| 0 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | 0.305 | 0.610 | 0C | 0 | 0 | 1 | 1 | 1 | 1 | 0 | 0 | 0.545 | 1.090 | 3C |
| 0 | 0 | 0 | 0 | 1 | 1 | 0 | 1 | 0.310 | 0.620 | 0D | 0 | 0 | 1 | 1 | 1 | 1 | 0 | 1 | 0.550 | 1.100 | 3D |
| 0 | 0 | 0 | 0 | 1 | 1 | 1 | 0 | 0.315 | 0.630 | 0E | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 0 | 0.555 | 1.110 | 3E |
| 0 | 0 | 0 | 0 | 1 | 1 | 1 | 1 | 0.320 | 0.640 | 0F | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 0.560 | 1.120 | 3F |
| 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0.325 | 0.650 | 10 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0.565 | 1.130 | 40 |
| 0 | 0 | 0 | 1 | 0 | 0 | 0 | 1 | 0.330 | 0.660 | 11 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 0.570 | 1.140 | 41 |
| 0 | 0 | 0 | 1 | 0 | 0 | 1 | 0 | 0.335 | 0.670 | 12 | 0 | 1 | 0 | 0 | 0 | 0 | 1 | 0 | 0.575 | 1.150 | 42 |
| 0 | 0 | 0 | 1 | 0 | 0 | 1 | 1 | 0.340 | 0.680 | 13 | 0 | 1 | 0 | 0 | 0 | 0 | 1 | 1 | 0.580 | 1.160 | 43 |
| 0 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | 0.345 | 0.690 | 14 | 0 | 1 | 0 | 0 | 0 | 1 | 0 | 0 | 0.585 | 1.170 | 44 |
| 0 | 0 | 0 | 1 | 0 | 1 | 0 | 1 | 0.350 | 0.700 | 15 | 0 | 1 | 0 | 0 | 0 | 1 | 0 | 1 | 0.590 | 1.180 | 45 |
| 0 | 0 | 0 | 1 | 0 | 1 | 1 | 0 | 0.355 | 0.710 | 16 | 0 | 1 | 0 | 0 | 0 | 1 | 1 | 0 | 0.595 | 1.190 | 46 |
| 0 | 0 | 0 | 1 | 0 | 1 | 1 | 1 | 0.360 | 0.720 | 17 | 0 | 1 | 0 | 0 | 0 | 1 | 1 | 1 | 0.600 | 1.200 | 47 |
| 0 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | 0.365 | 0.730 | 18 | 0 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 0.605 | 1.210 | 48 |
| 0 | 0 | 0 | 1 | 1 | 0 | 0 | 1 | 0.370 | 0.740 | 19 | 0 | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 0.610 | 1.220 | 49 |
| 0 | 0 | 0 | 1 | 1 | 0 | 1 | 0 | 0.375 | 0.750 | 1A | 0 | 1 | 0 | 0 | 1 | 0 | 1 | 0 | 0.615 | 1.230 | 4A |
| 0 | 0 | 0 | 1 | 1 | 0 | 1 | 1 | 0.380 | 0.760 | 1B | 0 | 1 | 0 | 0 | 1 | 0 | 1 | 1 | 0.620 | 1.240 | 4B |
| 0 | 0 | 0 | 1 | 1 | 1 | 0 | 0 | 0.385 | 0.770 | 1C | 0 | 1 | 0 | 0 | 1 | 1 | 0 | 0 | 0.625 | 1.250 | 4C |
| 0 | 0 | 0 | 1 | 1 | 1 | 0 | 1 | 0.390 | 0.780 | 1D | 0 | 1 | 0 | 0 | 1 | 1 | 0 | 1 | 0.630 | 1.260 | 4D |
| 0 | 0 | 0 | 1 | 1 | 1 | 1 | 0 | 0.395 | 0.790 | 1E | 0 | 1 | 0 | 0 | 1 | 1 | 1 | 0 | 0.635 | 1.270 | 4E |
| 0 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 0.400 | 0.800 | 1F | 0 | 1 | 0 | 0 | 1 | 1 | 1 | 1 | 0.640 | 1.280 | 4F |
| 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0.405 | 0.810 | 20 | 0 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 0.645 | 1.290 | 50 |
| 0 | 0 | 1 | 0 | 0 | 0 | 0 | 1 | 0.410 | 0.820 | 21 | 0 | 1 | 0 | 1 | 0 | 0 | 0 | 1 | 0.650 | 1.300 | 51 |
| 0 | 0 | 1 | 0 | 0 | 0 | 1 | 0 | 0.415 | 0.830 | 22 | 0 | 1 | 0 | 1 | 0 | 0 | 1 | 0 | 0.655 | 1.310 | 52 |
| 0 | 0 | 1 | 0 | 0 | 0 | 1 | 1 | 0.420 | 0.840 | 23 | 0 | 1 | 0 | 1 | 0 | 0 | 1 | 1 | 0.660 | 1.320 | 53 |
| 0 | 0 | 1 | 0 | 0 | 1 | 0 | 0 | 0.425 | 0.850 | 24 | 0 | 1 | 0 | 1 | 0 | 1 | 0 | 0 | 0.665 | 1.330 | 54 |
| 0 | 0 | 1 | 0 | 0 | 1 | 0 | 1 | 0.430 | 0.860 | 25 | 0 | 1 | 0 | 1 | 0 | 1 | 0 | 1 | 0.670 | 1.340 | 55 |
| 0 | 0 | 1 | 0 | 0 | 1 | 1 | 0 | 0.435 | 0.870 | 26 | 0 | 1 | 0 | 1 | 0 | 1 | 1 | 0 | 0.675 | 1.350 | 56 |
| 0 | 0 | 1 | 0 | 0 | 1 | 1 | 1 | 0.440 | 0.880 | 27 | 0 | 1 | 0 | 1 | 0 | 1 | 1 | 1 | 0.680 | 1.360 | 57 |
| 0 | 0 | 1 | 0 | 1 | 0 | 0 | 0 | 0.445 | 0.890 | 28 | 0 | 1 | 0 | 1 | 1 | 0 | 0 | 0 | 0.685 | 1.370 | 58 |
| 0 | 0 | 1 | 0 | 1 | 0 | 0 | 1 | 0.450 | 0.900 | 29 | 0 | 1 | 0 | 1 | 1 | 0 | 0 | 1 | 0.690 | 1.380 | 59 |
| 0 | 0 | 1 | 0 | 1 | 0 | 1 | 0 | 0.455 | 0.910 | 2A | 0 | 1 | 0 | 1 | 1 | 0 | 1 | 0 | 0.695 | 1.390 | 5A |
| 0 | 0 | 1 | 0 | 1 | 0 | 1 | 1 | 0.460 | 0.920 | 2B | 0 | 1 | 0 | 1 | 1 | 0 | 1 | 1 | 0.700 | 1.400 | 5B |
| 0 | 0 | 1 | 0 | 1 | 1 | 0 | 0 | 0.465 | 0.930 | 2C | 0 | 1 | 0 | 1 | 1 | 1 | 0 | 0 | 0.705 | 1.410 | 5C |
| 0 | 0 | 1 | 0 | 1 | 1 | 0 | 1 | 0.470 | 0.940 | 2D | 0 | 1 | 0 | 1 | 1 | 1 | 0 | 1 | 0.710 | 1.420 | 5D |
| 0 | 0 | 1 | 0 | 1 | 1 | 1 | 0 | 0.475 | 0.950 | 2E | 0 | 1 | 0 | 1 | 1 | 1 | 1 | 0 | 0.715 | 1.430 | 5E |
| 0 | 0 | 1 | 0 | 1 | 1 | 1 | 1 | 0.480 | 0.960 | 2F | 0 | 1 | 0 | 1 | 1 | 1 | 1 | 1 | 0.720 | 1.440 | 5F |

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Table 4. VR13 VID CODES

| VID7 | VID6 | VID5 | VID4 | VID3 | VID2 | VID1 | VID0 | Voltage(V) | | HEX | VID7 | VID6 | VID5 | VID4 | VID3 | VID2 | VID1 | VID0 | Voltage(V) | | HEX |
|------|------|------|------|------|------|------|------|------------|------------|-----|------|------|------|------|------|------|------|------|------------|------------|-----|
| | | | | | | | | 5 mV Mode | 10 mV Mode | | | | | | | | | | 5 mV Mode | 10 mV Mode | |
| | | | | | | | | | | | | | | | | | | | | | |
| 0 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0.725 | 1.450 | 60 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0.965 | 1.930 | 90 |
| 0 | 1 | 1 | 0 | 0 | 0 | 0 | 1 | 0.730 | 1.460 | 61 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 1 | 0.970 | 1.940 | 91 |
| 0 | 1 | 1 | 0 | 0 | 0 | 1 | 0 | 0.735 | 1.470 | 62 | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 0 | 0.975 | 1.950 | 92 |
| 0 | 1 | 1 | 0 | 0 | 0 | 1 | 1 | 0.740 | 1.480 | 63 | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 1 | 0.980 | 1.960 | 93 |
| 0 | 1 | 1 | 0 | 0 | 1 | 0 | 0 | 0.745 | 1.490 | 64 | 1 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | 0.985 | 1.970 | 94 |
| 0 | 1 | 1 | 0 | 0 | 1 | 0 | 1 | 0.750 | 1.500 | 65 | 1 | 0 | 0 | 1 | 0 | 1 | 0 | 1 | 0.990 | 1.980 | 95 |
| 0 | 1 | 1 | 0 | 0 | 1 | 1 | 0 | 0.755 | 1.510 | 66 | 1 | 0 | 0 | 1 | 0 | 1 | 1 | 0 | 0.995 | 1.990 | 96 |
| 0 | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 0.760 | 1.520 | 67 | 1 | 0 | 0 | 1 | 0 | 1 | 1 | 1 | 1.000 | 2.000 | 97 |
| 0 | 1 | 1 | 0 | 1 | 0 | 0 | 0 | 0.765 | 1.530 | 68 | 1 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | 1.005 | 2.010 | 98 |
| 0 | 1 | 1 | 0 | 1 | 0 | 0 | 1 | 0.770 | 1.540 | 69 | 1 | 0 | 0 | 1 | 1 | 0 | 0 | 1 | 1.010 | 2.020 | 99 |
| 0 | 1 | 1 | 0 | 1 | 0 | 1 | 0 | 0.775 | 1.550 | 6A | 1 | 0 | 0 | 1 | 1 | 0 | 1 | 0 | 1.015 | 2.030 | 9A |
| 0 | 1 | 1 | 0 | 1 | 0 | 1 | 1 | 0.780 | 1.560 | 6B | 1 | 0 | 0 | 1 | 1 | 0 | 1 | 1 | 1.020 | 2.040 | 9B |
| 0 | 1 | 1 | 0 | 1 | 1 | 0 | 0 | 0.785 | 1.570 | 6C | 1 | 0 | 0 | 1 | 1 | 1 | 0 | 0 | 1.025 | 2.050 | 9C |
| 0 | 1 | 1 | 0 | 1 | 1 | 0 | 1 | 0.790 | 1.580 | 6D | 1 | 0 | 0 | 1 | 1 | 1 | 0 | 1 | 1.030 | 2.060 | 9D |
| 0 | 1 | 1 | 0 | 1 | 1 | 1 | 0 | 0.795 | 1.590 | 6E | 1 | 0 | 0 | 1 | 1 | 1 | 1 | 0 | 1.035 | 2.070 | 9E |
| 0 | 1 | 1 | 0 | 1 | 1 | 1 | 1 | 0.800 | 1.600 | 6F | 1 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 1.040 | 2.080 | 9F |
| 0 | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0.805 | 1.610 | 70 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 1.045 | 2.090 | A0 |
| 0 | 1 | 1 | 1 | 0 | 0 | 0 | 1 | 0.810 | 1.620 | 71 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 1 | 1.050 | 2.100 | A1 |
| 0 | 1 | 1 | 1 | 0 | 0 | 1 | 0 | 0.815 | 1.630 | 72 | 1 | 0 | 1 | 0 | 0 | 0 | 1 | 0 | 1.055 | 2.110 | A2 |
| 0 | 1 | 1 | 1 | 0 | 0 | 1 | 1 | 0.820 | 1.640 | 73 | 1 | 0 | 1 | 0 | 0 | 0 | 1 | 1 | 1.060 | 2.120 | A3 |
| 0 | 1 | 1 | 1 | 0 | 1 | 0 | 0 | 0.825 | 1.650 | 74 | 1 | 0 | 1 | 0 | 0 | 1 | 0 | 0 | 1.065 | 2.130 | A4 |
| 0 | 1 | 1 | 1 | 0 | 1 | 0 | 1 | 0.830 | 1.660 | 75 | 1 | 0 | 1 | 0 | 0 | 1 | 0 | 1 | 1.070 | 2.140 | A5 |
| 0 | 1 | 1 | 1 | 0 | 1 | 1 | 0 | 0.835 | 1.670 | 76 | 1 | 0 | 1 | 0 | 0 | 1 | 1 | 0 | 1.075 | 2.150 | A6 |
| 0 | 1 | 1 | 1 | 0 | 1 | 1 | 1 | 0.840 | 1.680 | 77 | 1 | 0 | 1 | 0 | 0 | 1 | 1 | 1 | 1.080 | 2.160 | A7 |
| 0 | 1 | 1 | 1 | 1 | 0 | 0 | 0 | 0.845 | 1.690 | 78 | 1 | 0 | 1 | 0 | 1 | 0 | 0 | 0 | 1.085 | 2.170 | A8 |
| 0 | 1 | 1 | 1 | 1 | 0 | 0 | 1 | 0.850 | 1.700 | 79 | 1 | 0 | 1 | 0 | 1 | 0 | 0 | 1 | 1.090 | 2.180 | A9 |
| 0 | 1 | 1 | 1 | 1 | 0 | 1 | 0 | 0.855 | 1.710 | 7A | 1 | 0 | 1 | 0 | 1 | 0 | 1 | 0 | 1.095 | 2.190 | AA |
| 0 | 1 | 1 | 1 | 1 | 0 | 1 | 1 | 0.860 | 1.720 | 7B | 1 | 0 | 1 | 0 | 1 | 0 | 1 | 1 | 1.100 | 2.200 | AB |
| 0 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 0.865 | 1.730 | 7C | 1 | 0 | 1 | 0 | 1 | 1 | 0 | 0 | 1.105 | 2.210 | AC |
| 0 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | 0.870 | 1.740 | 7D | 1 | 0 | 1 | 0 | 1 | 1 | 0 | 1 | 1.110 | 2.220 | AD |
| 0 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 0.875 | 1.750 | 7E | 1 | 0 | 1 | 0 | 1 | 1 | 1 | 0 | 1.115 | 2.230 | AE |
| 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0.880 | 1.760 | 7F | 1 | 0 | 1 | 0 | 1 | 1 | 1 | 1 | 1.120 | 2.240 | AF |
| 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0.885 | 1.770 | 80 | 1 | 0 | 1 | 1 | 0 | 0 | 0 | 0 | 1.125 | 2.250 | B0 |
| 1 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0.890 | 1.780 | 81 | 1 | 0 | 1 | 1 | 0 | 0 | 0 | 1 | 1.130 | 2.260 | B1 |
| 1 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0.895 | 1.790 | 82 | 1 | 0 | 1 | 1 | 0 | 0 | 1 | 0 | 1.135 | 2.270 | B2 |
| 1 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0.900 | 1.800 | 83 | 1 | 0 | 1 | 1 | 0 | 0 | 1 | 1 | 1.140 | 2.280 | B3 |
| 1 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0.905 | 1.810 | 84 | 1 | 0 | 1 | 1 | 0 | 1 | 0 | 0 | 1.145 | 2.290 | B4 |
| 1 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | 0.910 | 1.820 | 85 | 1 | 0 | 1 | 1 | 0 | 1 | 0 | 1 | 1.150 | 2.300 | B5 |
| 1 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | 0.915 | 1.830 | 86 | 1 | 0 | 1 | 1 | 0 | 1 | 1 | 0 | 1.155 | 2.310 | B6 |
| 1 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 0.920 | 1.840 | 87 | 1 | 0 | 1 | 1 | 0 | 1 | 1 | 1 | 1.160 | 2.320 | B7 |
| 1 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0.925 | 1.850 | 88 | 1 | 0 | 1 | 1 | 1 | 0 | 0 | 0 | 1.165 | 2.330 | B8 |
| 1 | 0 | 0 | 0 | 1 | 0 | 0 | 1 | 0.930 | 1.860 | 89 | 1 | 0 | 1 | 1 | 1 | 0 | 0 | 1 | 1.170 | 2.340 | B9 |
| 1 | 0 | 0 | 0 | 1 | 0 | 1 | 0 | 0.935 | 1.870 | 8A | 1 | 0 | 1 | 1 | 1 | 0 | 1 | 0 | 1.175 | 2.350 | BA |
| 1 | 0 | 0 | 0 | 1 | 0 | 1 | 1 | 0.940 | 1.880 | 8B | 1 | 0 | 1 | 1 | 1 | 0 | 1 | 1 | 1.180 | 2.360 | BB |
| 1 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | 0.945 | 1.890 | 8C | 1 | 0 | 1 | 1 | 1 | 1 | 0 | 0 | 1.185 | 2.370 | BC |
| 1 | 0 | 0 | 0 | 1 | 1 | 0 | 1 | 0.950 | 1.900 | 8D | 1 | 0 | 1 | 1 | 1 | 1 | 0 | 1 | 1.190 | 2.380 | BD |
| 1 | 0 | 0 | 0 | 1 | 1 | 1 | 0 | 0.955 | 1.910 | 8E | 1 | 0 | 1 | 1 | 1 | 1 | 1 | 0 | 1.195 | 2.390 | BE |
| 1 | 0 | 0 | 0 | 1 | 1 | 1 | 1 | 0.960 | 1.920 | 8F | 1 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1.200 | 2.400 | BF |

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Table 4. VR13 VID CODES

| VID7 | VID6 | VID5 | VID4 | VID3 | VID2 | VID1 | VID0 | Voltage(V) | | HEX | VID7 | VID6 | VID5 | VID4 | VID3 | VID2 | VID1 | VID0 | Voltage(V) | | HEX |
|------|------|------|------|------|------|------|------|------------|------------|-----|------|------|------|------|------|------|------|------|------------|------------|-----|
| | | | | | | | | 5 mV Mode | 10 mV Mode | | | | | | | | | | 5 mV Mode | 10 mV Mode | |
| | | | | | | | | 1 | 1 | | | | | | | | | | 0 | 0 | |
| 1 | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 1.210 | 2.420 | C1 | 1 | 1 | 1 | 1 | 0 | 0 | 0 | 1 | 1.450 | 2.900 | F1 |
| 1 | 1 | 0 | 0 | 0 | 0 | 1 | 0 | 1.215 | 2.430 | C2 | 1 | 1 | 1 | 1 | 0 | 0 | 1 | 0 | 1.455 | 2.910 | F2 |
| 1 | 1 | 0 | 0 | 0 | 0 | 1 | 1 | 1.220 | 2.440 | C3 | 1 | 1 | 1 | 1 | 0 | 0 | 1 | 1 | 1.460 | 2.920 | F3 |
| 1 | 1 | 0 | 0 | 0 | 1 | 0 | 0 | 1.225 | 2.450 | C4 | 1 | 1 | 1 | 1 | 0 | 1 | 0 | 0 | 1.465 | 2.930 | F4 |
| 1 | 1 | 0 | 0 | 0 | 1 | 0 | 1 | 1.230 | 2.460 | C5 | 1 | 1 | 1 | 1 | 0 | 1 | 0 | 1 | 1.470 | 2.940 | F5 |
| 1 | 1 | 0 | 0 | 0 | 1 | 1 | 0 | 1.235 | 2.470 | C6 | 1 | 1 | 1 | 1 | 0 | 1 | 1 | 0 | 1.475 | 2.950 | F6 |
| 1 | 1 | 0 | 0 | 0 | 1 | 1 | 1 | 1.240 | 2.480 | C7 | 1 | 1 | 1 | 1 | 0 | 1 | 1 | 1 | 1.480 | 2.960 | F7 |
| 1 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 1.245 | 2.490 | C8 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 0 | 1.485 | 2.970 | F8 |
| 1 | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 1.250 | 2.500 | C9 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 1 | 1.490 | 2.980 | F9 |
| 1 | 1 | 0 | 0 | 1 | 0 | 1 | 0 | 1.255 | 2.510 | CA | 1 | 1 | 1 | 1 | 1 | 0 | 1 | 0 | 1.495 | 2.990 | FA |
| 1 | 1 | 0 | 0 | 1 | 0 | 1 | 1 | 1.260 | 2.520 | CB | 1 | 1 | 1 | 1 | 1 | 0 | 1 | 1 | 1.500 | 3.000 | FB |
| 1 | 1 | 0 | 0 | 1 | 1 | 0 | 0 | 1.265 | 2.530 | CC | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 1.505 | 3.010 | FC |
| 1 | 1 | 0 | 0 | 1 | 1 | 0 | 1 | 1.270 | 2.540 | CD | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | 1.510 | 3.020 | FD |
| 1 | 1 | 0 | 0 | 1 | 1 | 1 | 0 | 1.275 | 2.550 | CE | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 1.515 | 3.030 | FE |
| 1 | 1 | 0 | 0 | 1 | 1 | 1 | 1 | 1.280 | 2.560 | CF | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1.520 | 3.040 | FF |
| 1 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 1.285 | 2.570 | D0 | | | | | | | | | | | |
| 1 | 1 | 0 | 1 | 0 | 0 | 0 | 1 | 1.290 | 2.580 | D1 | | | | | | | | | | | |
| 1 | 1 | 0 | 1 | 0 | 0 | 1 | 0 | 1.295 | 2.590 | D2 | | | | | | | | | | | |
| 1 | 1 | 0 | 1 | 0 | 0 | 1 | 1 | 1.300 | 2.600 | D3 | | | | | | | | | | | |
| 1 | 1 | 0 | 1 | 0 | 1 | 0 | 0 | 1.305 | 2.610 | D4 | | | | | | | | | | | |
| 1 | 1 | 0 | 1 | 0 | 1 | 0 | 1 | 1.310 | 2.620 | D5 | | | | | | | | | | | |
| 1 | 1 | 0 | 1 | 0 | 1 | 1 | 0 | 1.315 | 2.630 | D6 | | | | | | | | | | | |
| 1 | 1 | 0 | 1 | 0 | 1 | 1 | 1 | 1.320 | 2.640 | D7 | | | | | | | | | | | |
| 1 | 1 | 0 | 1 | 1 | 0 | 0 | 0 | 1.325 | 2.650 | D8 | | | | | | | | | | | |
| 1 | 1 | 0 | 1 | 1 | 0 | 0 | 1 | 1.330 | 2.660 | D9 | | | | | | | | | | | |
| 1 | 1 | 0 | 1 | 1 | 0 | 1 | 0 | 1.335 | 2.670 | DA | | | | | | | | | | | |
| 1 | 1 | 0 | 1 | 1 | 0 | 1 | 1 | 1.340 | 2.680 | DB | | | | | | | | | | | |
| 1 | 1 | 0 | 1 | 1 | 1 | 0 | 0 | 1.345 | 2.690 | DC | | | | | | | | | | | |
| 1 | 1 | 0 | 1 | 1 | 1 | 0 | 1 | 1.350 | 2.700 | DD | | | | | | | | | | | |
| 1 | 1 | 0 | 1 | 1 | 1 | 1 | 0 | 1.355 | 2.710 | DE | | | | | | | | | | | |
| 1 | 1 | 0 | 1 | 1 | 1 | 1 | 1 | 1.360 | 2.720 | DF | | | | | | | | | | | |
| 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 1.365 | 2.730 | E0 | | | | | | | | | | | |
| 1 | 1 | 1 | 0 | 0 | 0 | 0 | 1 | 1.370 | 2.740 | E1 | | | | | | | | | | | |
| 1 | 1 | 1 | 0 | 0 | 0 | 1 | 0 | 1.375 | 2.750 | E2 | | | | | | | | | | | |
| 1 | 1 | 1 | 0 | 0 | 0 | 1 | 1 | 1.380 | 2.760 | E3 | | | | | | | | | | | |
| 1 | 1 | 1 | 0 | 0 | 1 | 0 | 0 | 1.385 | 2.770 | E4 | | | | | | | | | | | |
| 1 | 1 | 1 | 0 | 0 | 1 | 0 | 1 | 1.390 | 2.780 | E5 | | | | | | | | | | | |
| 1 | 1 | 1 | 0 | 0 | 1 | 1 | 0 | 1.395 | 2.790 | E6 | | | | | | | | | | | |
| 1 | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 1.400 | 2.800 | E7 | | | | | | | | | | | |
| 1 | 1 | 1 | 0 | 1 | 0 | 0 | 0 | 1.405 | 2.810 | E8 | | | | | | | | | | | |
| 1 | 1 | 1 | 0 | 1 | 0 | 0 | 1 | 1.410 | 2.820 | E9 | | | | | | | | | | | |
| 1 | 1 | 1 | 0 | 1 | 0 | 1 | 0 | 1.415 | 2.830 | EA | | | | | | | | | | | |
| 1 | 1 | 1 | 0 | 1 | 0 | 1 | 1 | 1.420 | 2.840 | EB | | | | | | | | | | | |
| 1 | 1 | 1 | 0 | 1 | 1 | 0 | 0 | 1.425 | 2.850 | EC | | | | | | | | | | | |
| 1 | 1 | 1 | 0 | 1 | 1 | 0 | 1 | 1.430 | 2.860 | ED | | | | | | | | | | | |
| 1 | 1 | 1 | 0 | 1 | 1 | 1 | 0 | 1.435 | 2.870 | EE | | | | | | | | | | | |
| 1 | 1 | 1 | 0 | 1 | 1 | 1 | 1 | 1.440 | 2.880 | EF | | | | | | | | | | | |

Table 5. SUPPORTED SVID COMMANDS

| # | Command | Master Payload | Slave Payload | Description |
|-----|--------------|--|-----------------------------|--|
| 01h | SetVID_Fast | VID Code | N | Set the new VID target, VR Jumps to new VID target with controlled (up or down) slew rate programmed by the VR. |
| 02h | SetVID_Slow | VID Code | N/A | Set the VID target, VR jumps to new VID target with controlled slew rate (up or down) programmed by the VR. |
| 03h | SetVID_Decay | VID Code | N/A | Sets the VID target, VR jumps to new VID target, but does not control the slew rate, the output voltage decays at a rate proportional to the load current. SetVID_Decay is only used in VID down direction. |
| 04h | SetPS | Byte indicating power state for slave | N/A | Sends information to VR controller so it can configure VR to improve efficiency, especially at light load. |
| 05h | SetRegAddr | Address of the index in the data table | N/A | Sets the address pointer in the data register table. Typically the next command SetRegData is the payload that gets loaded into this address. |
| 06h | SetRegData | New data register contents | N/A | Writes the contents to the data register that was previously identified by the address pointer with SetRegAddr. |
| 07h | GetReg | Register Address | Specified register contents | Slave returns the contents of the specified register as the payload; The majority of the VR monitoring data is accessed through the GetReg command. |
| 08h | Test Mode | | | For evaluation purpose only. |
| 09h | SetWP | Byte indicating the working point, slew rate, and alert to select. | N/A | SetWP payload is a bit mapped word that identifies the WP registers which hold the new target VID code, transition slew rate, and alert# behavior when the voltage rails transition to the new voltage targets. |

Table 6. SUPPORTED SVID REGISTERS

| Index | Name | Description | Master Access | Default |
|-------|------------------|---|---------------|---------|
| 00h | Vendor ID | Uniquely identifies the VR vendor. The vendor ID assigned by Intel to ON Semiconductor is 0x1Ah | R | 1Ah |
| 01h | Product ID | Uniquely identifies the VR product. The VR vendor assigns this number. | R | 85h |
| 02h | Product Revision | Uniquely identifies the revision or stepping of the VR control IC. | R | 00h |
| 03h | Date code ID | | R | 00h |
| 05h | Protocol ID | Identifies the SVID protocol the controller supports. 07h = VR13.0 and 5 mV VID; 04h = VR13.0 and 10 mV VID. | R | 07h |
| 06h | Capability | <p>Informs the Master of the controller's Capabilities, 1 = supported, 0 = not supported</p> <p>Bit 7 = I_{out}_format. Bit 7 = 0 when 1A = 1LSB of Reg 15h. Bit 7 = 1 when Reg 15 FFh = I_{cc}_Max. Default = 1</p> <p>Bit 6 = ADC Measurement of Temp Supported = 1</p> <p>Bit 5 = ADC Measurement of Pin Supported = 0</p> <p>Bit 4 = ADC Measurement of V_{in} Supported = 0</p> <p>Bit 3 = ADC Measurement of I_{in} Supported = 0</p> <p>Bit 2 = ADC Measurement of P_{out} Supported = 0</p> <p>Bit 1 = ADC Measurement of V_{out} Supported = 0</p> <p>Bit 0 = ADC Measurement of I_{out} Supported = 1</p> | R | C1h |
| 10h | Status_1 | Data register read after ALERT# signal is asserted. Conveying the status of the VR. (pp.94, Intel #456098) | R | 00h |
| 11h | Status_2 | Data register showing optional status_2 data. (pp.94, Intel #456098) | R | 00h |
| 12h | Temp Zone | Data register showing temperature zones the system is operating in. (pp.106, Intel #456098) 1 tick is 3 °C. | R | 00h |
| 15h | I _{out} | 8 bit binary word ADC of current. The ADC should be scaled such that FFh=IMAX for the VR for maximum resolution of the ADC data. | R | 00h |

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Table 6. SUPPORTED SVID REGISTERS

| Index | Name | Description | Master Access | Default |
|-------|--------------------|---|---------------|---------|
| 16h | V_out | Not supported. | R | 00h |
| 17h | VR_Temp | 8 bit binary word ADC of temperature. Binary format in °C, i.e. 64h = 100°C. 00h indicates this function is not supported. Default value of 19h means 25°C. | R | 19h |
| 18h | P_out | Not supported. | R | |
| 1Bh | PIN_H | Not supported. | R | |
| 1Ch | Status 2 Last read | When the status 2 register is read its contents are copied into this register. The format is the same as the Status 2 Register. | R | 00h |
| 21h | Icc_Max | Data register containing the Icc_Max. 1 LSB means 1 A. Default value 19h = 25 A. | R | 19h |
| 22h | Temp_Max | Data register containing the max temperature and the level VR_hot asserts. This value defaults to 100°C. | R | 64h |
| 24h | SR_fast | Slew Rate for SetVID_fast commands. Binary format in mV/us. | R | 0Ah |
| 25h | SR_slow | Slew Rate for SetVID_slow commands. It is 4X slower than the SR_fast rate. Binary format in mV/us | R | 02h |
| 26h | Vboot | The NCP3293 ramps to Vboot and hold at Vboot until it receives a new SVID SetVID command to move to a different voltage. Default value = 0 V. | R | 00h |
| 2Ah | SR_Slow Selector | 01h = Fast_SR/2 02h = Fast_SR/4 (Default) 04h = Fast_SR/8 08h = Fast_SR/16 | R/W | 02h |
| 2Eh | Pin_Max | Not supported. | R | |
| 2Fh | Pin_Alert_TH | Not supported. | R | |
| 30h | Vout_Max | Programmed by master and sets the maximum VID the VR will support. If a higher VID code is received, the VR should respond with "not supported" acknowledge. VR 13 VID format. Default values are FFh (1.52 V) in 5 mV mode and 97h (2.0 V) in 10 mV mode. | R/W | FFh |
| 31h | VID setting | Data register containing currently programmed VID voltage. VID data format. | R | 00h |
| 32h | Pwr State | Register containing the current programmed power state. | R/W | 00h |
| 33h | Offset | Sets offset in VID steps added to the VID setting for voltage margining. Bit 7 is sign bit, 0=positive margin, 1= negative margin. Remaining 7 BITS are # VID steps for margin 2s complement. 00h = no offset 01h = +1 VID step 02h = +2 VID steps FFh = -1 VID step FEh = -2 VID steps. | R/W | 00h |
| 34h | MultiVR Config | VR_Ready_0V=1; The VR_Ready line does not de-assert when issued a SetVID(0.0V) or SetPS(4) command. | R | 01h |
| 3Ah | Work Point 0 | VID target for WP0 command | R/W | 00h |
| 3Bh | Work Point 1 | VID target for WP1 command | R/W | 00h |
| 3Ch | Work Point 2 | VID target for WP2 command | R/W | 00h |
| 3Dh | Work Point 3 | VID target for WP3 command | R/W | 00h |
| 3Eh | Work Point 4 | VID target for WP4 command | R/W | 00h |

NCP3293

DETAILED DESCRIPTION

General

The NCP3293, a single-phase synchronous buck regulator with SVID, integrates power MOSFETs to provide a high-efficiency and compact-footprint power management solution. The NCP3293 is able to deliver up to 20 A TDC output current on a wide output voltage range. Operating in high switching frequency up to 1 MHz allows employing small size inductors and capacitors while maintaining high

efficiency due to integrated solution with high performance power MOSFETs. It provides differential voltage sense and comprehensive protections.

Operation Modes

Operation mode, switching frequency, VID mode, and fast DVID slew rate are programmed at Mode pin with a $\pm 1\%$ tolerance resistor as shown in Table 7.

Table 7. MODE CONFIGURATION

| Resistance @ Mode Pin (Ω , $\pm 1\%$) | Frequency (kHz) | Operation Mode (PS0 and PS1) | VID Mode | | SR_fast | |
|--|-----------------|------------------------------|----------------------|------------------------|----------------|----------------|
| | | | VBOOT = 0 V to 1.5 V | VBOOT = 1.6 V to 1.8 V | | |
| 0 | 600 | FCCM | 5 mV | 10 mV | 10 mV/ μ s | |
| 499 | 800 | | | | 20 mV/ μ s | |
| 825 | 1000 | | | | 10 mV | 10 mV/ μ s |
| 1.15k | 800 | | | | | |
| 1.62k | 600 | | | | | |
| 2.00k | 800 | | | | | |
| 2.49k | 1000 | | | | | |
| 3.16k | 800 | | | | | |
| 3.83k | 600 | | | | | |
| 4.64k | 800 | Auto DCM/CCM | 5 mV | 10 mV | | |
| 5.62k | 1000 | | | | | |
| 6.65k | 1000 | | | | | |
| 7.87k | 800 | | | | | |
| 9.09k | 600 | | | | | |
| 10.5k | 600 | | | | | |
| 12.1k | 800 | | | | | |
| 14.0k | 1000 | | | | | |
| 16.2k | 1000 | FCCM | 10 mV | 10 mV | 20 mV/ μ s | |
| 18.7k | 800 | | | | | |
| 21.5k | 600 | | | | | |
| 24.9k | 600 | | | | | |
| 28.7k | 800 | | | | | |
| 33.2k | 1000 | | | | | |
| Float | 800 | | | | | |
| | | | | | | 5 mV |

The NCP3293 may operate in one of three power states, named PS0 (default), PS1, and PS2 as shown in Table 8, which is programmed by SVID SetPS command. The NCP3293 can acknowledge commands of SetPS3 and

SetPS4 but actually goes into PS2 mode after receiving those commands. The operation mode in PS0 and PS1 is selected at Mode pin. For VR13 applications, FCCM mode needs to be selected for PS0 and PS1.

Table 8. POWER STATUS AND OPERATION MODES

| Power Status | Operation Mode |
|--------------|--|
| PS0 | Forced CCM or Auto CCM/DCM (by Mode Pin) – normal mode (Default) |
| PS1 | Forced CCM or Auto CCM/DCM (by Mode Pin) – low power mode |
| PS2 | Auto CCM/DCM –very low power mode |

To have a consistent mode-change behavior and eliminate possible gate driver failures in response to SVID SetPS command, an internal mode-change synchronization circuit is employed. After receipt of SetPS command, the internal mode-change signal is triggered at either a rising edge of PWM signal or a time-out signal on a first-come first-served basis. The time-out signal is asserted when both high-side and low-side MOSFETs are off for more than 200 ns in DCM operation.

Current-Mode RPM Operation

The NCP3293 operates with the current-mode Ramp-Pulse-Modulation (RPM) scheme in PS0/1/2/3 operation states. In Forced CCM mode, the inductor current is always continuous and the device operates in quasi-fixed switching frequency, which has a typical value programmed by users through a resistor at pin FREQ. In Auto CCM/DCM mode, the inductor current is continuous and the device operates in quasi-fixed switching frequency in medium and heavy load range, while the inductor current becomes discontinuous and the device automatically operates in PFM mode with an adaptive fixed on time and variable switching frequency in light load range.

Serial VID interface (SVID)

The NCP3293 supports Intel serial VID interface. It communicates with the microprocessor through three wires (Clk, Data, ALERT#). Clk, Data and ALERT# should be pulled high to CPU I/O voltage VTT (which is typically 1.0 to 1.1 V) using external Resistors. The SVID bus will operate at a frequency up to 43 MHz. For NCP3293, supported SVID commands are listed in Table 5. All the supported registers are shown in Table 6.

SVID Address and Boot-Up Voltage

SVID address is programmed at Addr pin and boot-up voltage is programmed at Vboot pin as shown in Table 9 and Table 10.

ICC_MAX and I_OUT

The NCP3293 reports output current I_{OUT} as a linear fraction of a full-scale output current named I_{MAX}. I_{MAX} has 9 discrete levels, which should be selected according to the current limit set in the application with an essential margin. The NCP3293 detects external resistance R_{lim} at I_{lim} pin during system reset time before soft start and stores a corresponding I_{MAX} value into Icc_Max register as shown in Table 11. The real output current value I_{OUT} can be obtained from the reading I_{out} in the register 0x15h with a converting factor of I_{MAX}/255.

$$I_{OUT} = \frac{I_{out_{15h}}}{255} \cdot I_{MAX} \quad (eq. 1)$$

Table 9. SVID ADDRESS SELECTION

| Resistance (+/-1%) @ Addr Pin | SVID Address |
|-------------------------------|--------------|
| Float | 1111b |
| 150k | 1110b |
| 127k | 1101b |
| 105k | 1100b |
| 88.7k | 1011b |
| 75.0k | 1010b |
| 61.9k | 1001b |
| 51.1k | 1000b |
| 43.2k | 0111b |
| 36.5k | 0110b |
| 30.1k | 0101b |
| 21.0k | 0100b |
| 14.0k | 0011b |
| 9.53k | 0010b |
| 5.62k | 0001b |
| 0 | 0000b |

Table 10. BOOT-UP VOLTAGE SELECTION

| Resistance (+/-1%) @ Vboot Pin | Boot-Up Voltage (V) |
|--------------------------------|---------------------|
| Float | 1.8 |
| 150k | 1.7 |
| 127k | 1.6 |
| 105k | 1.5 |
| 88.7k | 1.35 |
| 75.0k | 1.25 |
| 61.9k | 1.2 |
| 51.1k | 1.1 |
| 43.2k | 1.05 |
| 36.5k | 1.0 |
| 30.1k | 0.95 |
| 21.0k | 0.9 |
| 14.0k | 0.85 |
| 9.53k | 0.8 |
| 5.62k | 0.75 |
| 0 | 0 |

Table 11. ICC_MAX PROGRAMMING

| Resistance (±1%) @ Ilim Pin | I _{MAX} (A) | ICC_MAX Register (21h) | Valley Current Limit (A) |
|-----------------------------|----------------------|------------------------|--------------------------|
| R _{LIM} = 31.6 kΩ | 35 | 23h | 30 |
| R _{LIM} = 26.1 kΩ | 30 | 1Eh | 25 |
| R _{LIM} = 21.0 kΩ | 25 | 19h | 20 |
| R _{LIM} = 15.4 kΩ | 20 | 14h | 15 |
| R _{LIM} = 10.2 kΩ | 15 | 0Fh | 10 |
| R _{LIM} = 5.23 kΩ | 10 | 0Ah | 5 |

Enable and Input UVLO

The NCP3293 is enabled when the voltage at EN pin is higher than an internal threshold V_{EN_TH}. A hysteresis can be programmed by an external resistor R_{EN} connected to EN pin as shown in Figure 4. The high threshold V_{EN_H} in ENABLE signal is

$$V_{EN_H} = V_{EN_TH} \tag{eq. 2}$$

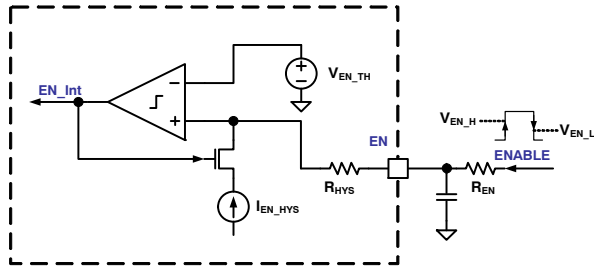


Figure 4. Enable and Hysteresis Programming

The low threshold V_{EN_L} in ENABLE signal is

$$V_{EN_L} = V_{EN_TH} - V_{EN_HYS} \tag{eq. 3}$$

The hysteresis V_{EN_HYS} is

$$V_{EN_HYS} = I_{EN_HYS} \cdot (R_{HYS} + R_{EN}) \tag{eq. 4}$$

A UVLO function for input power supply can be implemented at EN pin. As shown in Figure 5, the UVLO

Over Current Protection (OCP)

The NCP3293 protects converter from over current by a cycle-by-cycle current limitation. The average current limit I_{LMT} can be calculated from the programmed valley current limit I_{LMT_Valley} and inductor current ripple.

$$I_{LMT} = I_{LMT_Valley} + \frac{V_O \cdot (V_{IN} - V_O)}{2 \cdot V_{IN} \cdot L \cdot F_{SW}} = 9.62 \cdot 10^{-4} \cdot R_{Ilim} + \frac{V_O \cdot (V_{IN} - V_O)}{2 \cdot V_{IN} \cdot L \cdot F_{SW}} \tag{eq. 8}$$

where R_{Ilim} is resistance of the programming resistor at Ilim pin, V_{IN} is input voltage, V_O is output voltage, L is filter inductance, and F_{SW} is nominal switching frequency.

OCP detection starts from beginning of soft-start time TSS, and ends in shutdown. Inductor current is monitored by voltage sensing between SW pin and PGND pin. If over current happens and lasts for more than 50 μs, the device latches off. The device may trip under voltage protection before OCP latch-off if output voltage drops down very fast.

threshold can be programmed by two external resistors. The high threshold V_{IN_H} in VIN signal is

$$V_{IN_H} = \left(\frac{R_{EN1}}{R_{EN2}} + 1 \right) \cdot V_{EN_TH} \tag{eq. 5}$$

The low threshold V_{IN_L} in VIN signal is

$$V_{IN_L} = V_{IN_H} - V_{IN_HYS} \tag{eq. 6}$$

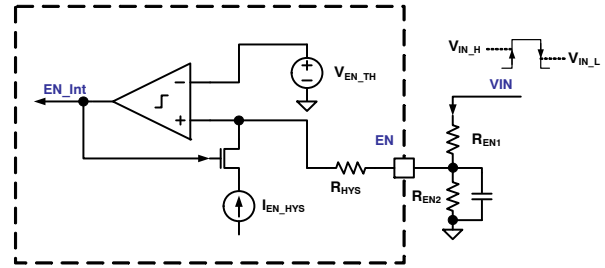


Figure 5. Enable and Input Supply UVLO Circuit

The hysteresis V_{IN_HYS} is

$$V_{IN_HYS} = I_{EN_HYS} \cdot \left(R_{HYS} \left(1 + \frac{R_{EN1}}{R_{EN2}} \right) + R_{EN1} \right) \tag{eq. 7}$$

To avoid undefined operation, EN pin should not be left float in applications.

To restart the device after OCP latch-off, the system needs to have either VCC or EN toggled state.

Under Voltage Protection (UVP)

UVP detection starts when PGOOD delay Td_PGOOD is expired right after soft start, and ends in shutdown. The NCP3293 pulls PGOOD low and turns off both high-side and low-side MOSFETs once FB voltage drops below 0.2 V for more than 1.0 μs. To restart the device after UVP

latch-off, the system needs to have either VCC or EN toggled state.

Over Voltage Protection (OVP)

OVP detection starts from the beginning of soft-start time TSS and ends in shutdown. During normal operation the output voltage is monitored at FB pin. If FB voltage exceeds the OVP threshold for more than 1 μ s, OVP is triggered and PGOOD is pulled low. In the meanwhile, the high-side MOSFET is latched off and the low-side MOSFET is turned on. After the OVP trips, the DAC ramps slowly down to

zero, having a negative slew rate as the same value of soft start to reduce negative output voltage spike. The low-side MOSFET toggles between on and off as the output voltage follows the OVP threshold down with a hysteresis. After the DAC gets to zero, the high-side MOSFET holds off and the low-side MOSFET keeps on. During soft-start, the OVP threshold is set to a fixed value of 2.0 V, and it changes to DAC+200 mV after DAC starts to ramp down due to OVP. To restart the device from OVP latch-off, the system needs to have either VCC or EN toggled state.

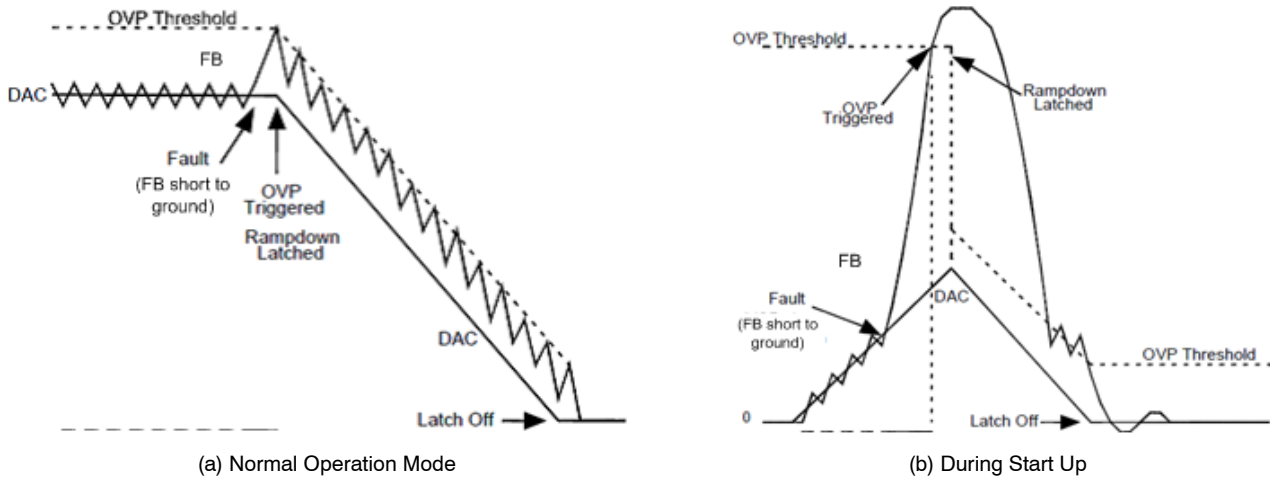


Figure 6. Function of Over Voltage Protection

Thermal Shutdown (TSD)

The NCP3293 has an internal thermal shutdown protection to protect the device from overheating in an extreme case that the die temperature exceeds 150°C. TSD detection is activated when VCC and EN are valid. Once the

thermal protection is triggered, the whole chip shuts down. If the temperature drops below 125°C, the system automatically recovers and a normal power-up sequence follows.

LAYOUT GUIDELINES

Electrical Layout Considerations

Good electrical layout is a key to make sure proper operation, high efficiency, and noise reduction. Electrical layout guidelines are:

- **Power Paths:** Use wide and short traces for power paths (such as VIN, VOUT, SW, and PGND) to reduce parasitic inductance and high-frequency loop area. It is also good for efficiency improvement.
- **Power Supply Decoupling:** The device should be well decoupled by input capacitors and input loop area should be as small as possible to reduce parasitic inductance, input voltage spike, and noise emission. Usually, a small low-ESL MLCC is placed very close to PVIN and PGND pins.
- **VCC Decoupling:** Place decoupling caps as close as possible to the controller VCC and VDRV pins. The filter resistor at VCC pin should be not higher than 2.2 Ω to prevent large voltage drop.
- **Switching Node:** SW node should be a copper pour, but compact because it is also a noise source.
- **Bootstrap:** The bootstrap cap and an option resistor need to be very close and directly connected between pin 26 (BST) and pin 25 (PHASE). No need to externally connect pin 25 to SW node because it has been internally connected to other SW pins.
- **Ground:** It would be good to have multiple ground planes. Directly connect the exposed PGND pad to

ground plane through multiple vias. Connect AGND pin to ground planes through a via close to the pin.

- **Voltage Sense:** Use Kelvin sense pair and arrange a “quiet” path for the differential output voltage sense. Keep the FB trace short to minimize its capacitance to ground.
- **SVID Bus:** The Serial VID bus is a high speed data bus and the bus routing should be done to limit noise coupling from the switching node. The SVID lines must be ground referenced and each line’s width and spacing should be such that they have nominal 50 Ω impedance with the board stackup. For details, please refer to Intel SVID routing guidelines.

Thermal Layout Considerations

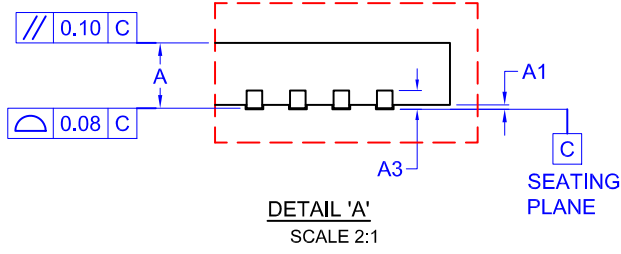
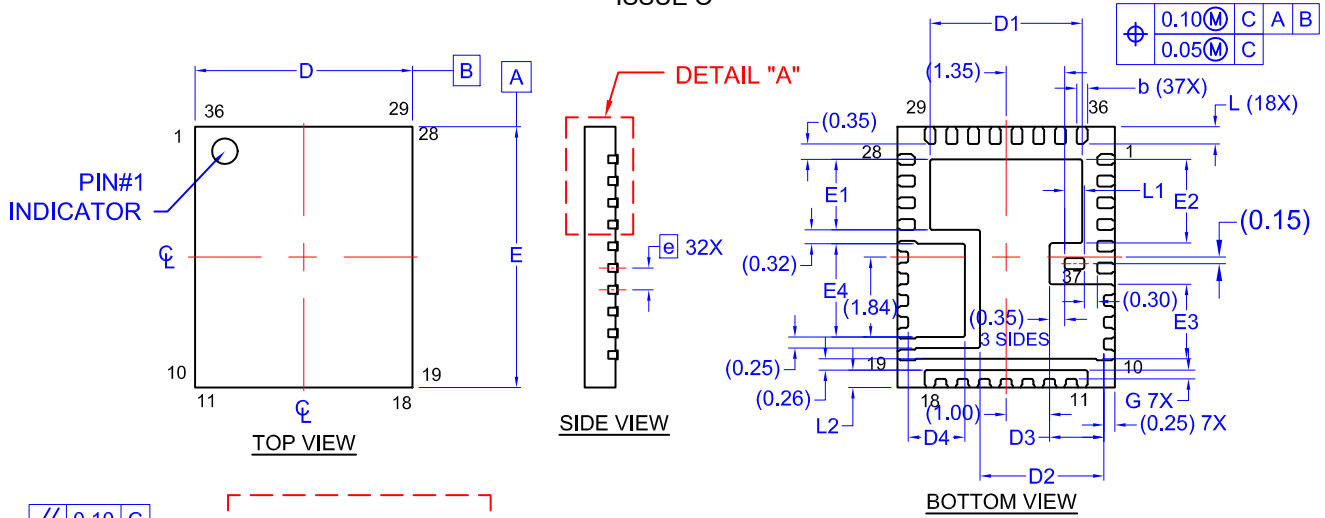
Good thermal layout helps high power dissipation from a small package with reduced temperature rise. Thermal layout guidelines are:

- The exposed pads must be well soldered on the board.
- A four or more layers PCB board with solid ground planes is preferred for better heat dissipation.
- More free vias are welcome to be around IC and underneath the exposed pads to connect the inner ground layers to reduce thermal impedance.
- Use large area copper pour to help thermal conduction and radiation.
- Do not put the inductor to be too close to the IC, thus the heat sources are distributed.

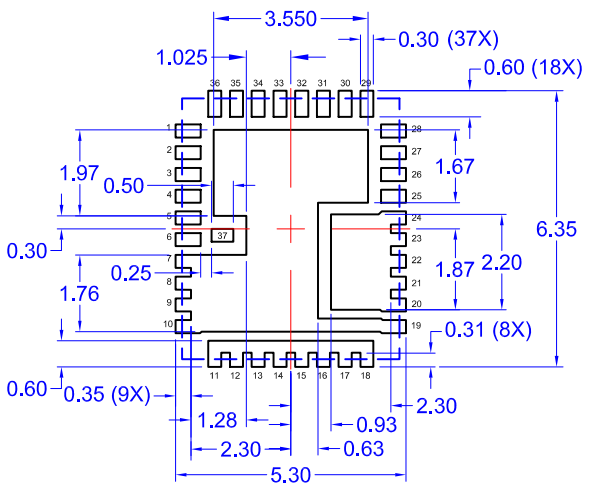
NCP3293

PACKAGE DIMENSIONS

PQFN37 5x6, 0.5P
CASE 483BZ
ISSUE O




| DIM | MILLIMETERS | | | DIM | MILLIMETERS | | |
|-----|-------------|------|------|-----|-------------|------|------|
| | MIN | NOM | MAX | | MIN | NOM | MAX |
| A | 0.70 | 0.75 | 0.80 | E4 | 2.04 | 2.14 | 2.24 |
| A1 | 0.00 | - | 0.05 | e | 0.50 BSC | | |
| A3 | 0.20 REF | | | G | 0.15 | 0.20 | 0.25 |
| b | 0.20 | 0.25 | 0.30 | L | 0.30 | 0.40 | 0.50 |
| D | 4.90 | 5.00 | 5.10 | L1 | 0.35 | 0.45 | 0.55 |
| D1 | 3.40 | 3.50 | 3.60 | L2 | 0.30 | 0.40 | 0.50 |
| D2 | 2.75 | 2.85 | 2.95 | M | 0.35 | 0.45 | 0.55 |
| D3 | 1.15 | 1.25 | 1.35 | | | | |
| D4 | 1.20 | 1.30 | 1.40 | | | | |
| E | 5.90 | 6.00 | 6.10 | | | | |
| E1 | 1.52 | 1.62 | 1.72 | | | | |
| E2 | 1.82 | 1.92 | 2.02 | | | | |
| E3 | 1.62 | 1.72 | 1.82 | | | | |



NOTES: UNLESS OTHERWISE SPECIFIED
 A) ALL DIMENSIONS ARE IN MILLIMETERS.
 B) DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH. MOLD FLASH OR BURRS DOES NOT EXCEED 0.10MM.

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